

FEATURES

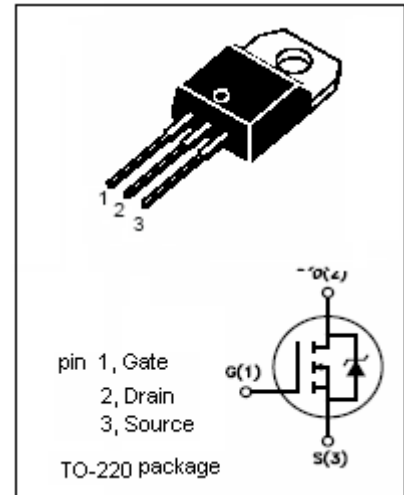
- Drain Current $-I_D = 80A @ T_C = 25^\circ C$
- Drain Source Voltage-
: $V_{DSS} = 75V(\text{Min})$
- Static Drain-Source On-Resistance
: $R_{DS(on)} = 0.015\Omega (\text{Max})$

DESCRIPTION

Suitable as primary switch in advanced high-efficiency, high-frequency isolated DC-DC converters for Telecom and Computer applications. It is also intended for any application with low gate drive requirements .

APPLICATIONS

- Solenoid and relay drivers
- DC motor control
- DC-DC converters DC
- Automotive environment



ABSOLUTE MAXIMUM RATINGS($T_a = 25^\circ C$)

SYMBOL	PARAMETER	VALUE	UNIT
V_{DSS}	Drain-Source Voltage	75	V
V_{GS}	Gate-Source Voltage-Continuous	± 20	V
I_D	Drain Current-Continuous	80	A
I_{DM}	Drain Current-Single Pluse ($t_p \leq 10\mu s$)	320	A
P_D	Total Dissipation @ $T_C = 25^\circ C$	300	W
T_J	Max. Operating Junction Temperature	150	$^\circ C$
T_{stg}	Storage Temperature	-55~150	$^\circ C$

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	MAX	UNIT
$R_{th j-c}$	Thermal Resistance, Junction to Case	0.5	$^\circ C/W$
$R_{th j-a}$	Thermal Resistance, Junction to Ambient	62.5	$^\circ C/W$

N-Channel MOSFET Transistor

HL75N75

ELECTRICAL CHARACTERISTICS

$T_C=25^{\circ}\text{C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN	MAX	UNIT
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0; I_D=0.25\text{mA}$	75		V
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}; I_D=0.25\text{mA}$	2	4	V
$R_{DS(on)}$	Drain-Source On-Resistance	$V_{GS}=10\text{V}; I_D=37.5\text{A}$		0.011	Ω
I_{GSS}	Gate-Body Leakage Current	$V_{GS}=\pm 20\text{V}; V_{DS}=0$		± 100	nA
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=75\text{V}; V_{GS}=0$ $V_{DS}=75\text{V}; V_{GS}=0; T_j=125^{\circ}\text{C}$		1.0 10	μA
V_{SD}	Forward On-Voltage	$I_S=75\text{A}; V_{GS}=0$		1.5	V